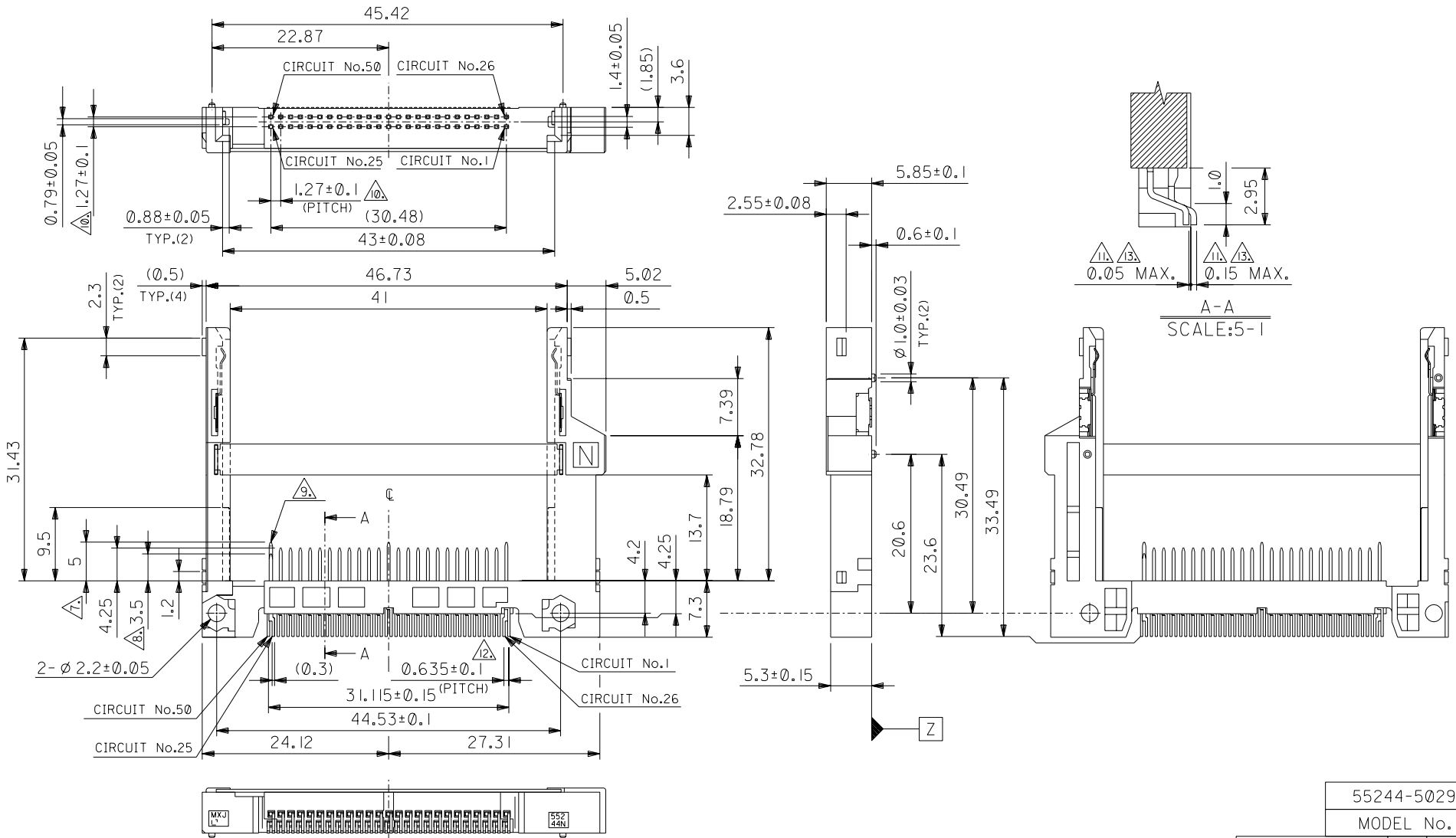


DWG. NO.
SD-55244-009



DO NOT SCALE DRAWING

EC NO. DRAWN: CHK'g: APPR:	EC NO. DRAWN: CHK'g: APPR:	EC NO. DRAWN: CHK'g: APPR:	EC NO. DRAWN: CHK'g: APPR:	EC NO. DRAWN: CHK'g: APPR:	EC NO.-J2004-3185 DRAWN: T.UENO CHK'g: M.SASAO APPR: M.SASAO	DESCRIPTION RELEASED '04/03/18	MATERIAL 材料 SEE NOTES	GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差	SCALE — mm INCH	DESIGN UNITS <input checked="" type="checkbox"/> mm <input type="checkbox"/> INCH	THIRD ANGLE PROJECTION	DIMENSIONS: <input type="checkbox"/> mm <input type="checkbox"/> INCH <input checked="" type="checkbox"/> mm ONLY	SHT REVISE ON CAD ONLY
							SEE NOTES	10 UNDER 未滿	±0.2	DRAWN BY & DATE T.UENO '04/03/18	TITLE: CF CARD CONN. 50P HEADER ASS'Y (NORMAL TYPE) -LEAD FREE-		
							SEE NOTES	10 OVER 30 UNDER 未滿	±0.25	CHECKED BY & DATE M.SASAO '04/03/18			
								30 OVER 以上	±0.3	APPROVED BY & DATE M.SASAO '04/03/18	MOLEX INCORPORATED		
							WIRE RANGE 適用電線範圍	ANGLE 角度	±3°	CAD FILENAME SD-55244-009.S01	MATERIAL NO. 55244-5029	DRAWING NO. SD-55244-009	SHEET NO. 1 OF 2
							INS. RANGE 被覆外径			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.		SIZE B	

55244-5029
MODEL No.

NOTES

MATERIAL

PIN: PHOSPHOR BRONZE

NAIL: PHOSPHOR BRONZE

PLATING

$t \geq 0.8$ MIN.
RECOMMENDED P.C.B. THICKNESS: $t \geq 0.8$ MIN.

~~42.8 ± 0.1~~
RECOMMENDED CARD WIDTH: 42.8 ± 0.1

HOUSING COLOR: BLACK

~~1.13, 38, 50~~
THIS DIMENSION APPLIES TO CIRCUIT NUMBERS
1, 13, 38 AND 50.



~~25, 26~~
THIS DIMENSION APPLIES TO CIRCUIT NUMBERS 25 AND 26.
 0.1 MAX.

NON-CUMULATIVE

PIN TIP LEAN TOWARD ANY DIRECTION NOT TO EXCEED 0.1
WHEN MEASURED FROM PIN BASE.

THIS DIMENSION TO BE MEASURED AT PIN BASE.

(3.25mm)

0.12 MAX. 0.05 0.15

0.15 DOWNWARD FROM Z-DATUM PLACE, AND COPLANARITY OF
SOLDERTAILS TO BE WITHIN 0.12 .
MEASUREMENT POINT IS SOLDERTAILS TIP.